

## COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SYSTEM FOR AND METHOD OF ANALYZING SURFACE CONDITION OF  
PCB USING RGB COLORS the specification of which

(check one) ☒ is attached hereto. ☐ was filed on \_\_\_\_\_, as United States Application Serial No. \_\_\_\_\_ or PCT International Application No. \_\_\_\_\_, and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 (a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority claimed

<u>2003-31620</u>	<u>KOREA</u>	<u>May 19, 2003</u>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	Day/month/year filed	Yes	No
_____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	Day/month/year filed	Yes	No

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

_____	_____
(Application No.)	(Filing Date)
_____	_____
(Application No.)	(Filing Date)
_____	_____
(Application No.)	(Filing Date)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

_____	_____	_____
(Application No.)	(Filing date)	(Status: patented, pending, abandoned)
_____	_____	_____
(Application No.)	(Filing date)	(Status: patented, pending, abandoned)
_____	_____	_____
(Application No.)	(Filing date)	(Status: patented, pending, abandoned)

And I hereby appoint

George Gottlieb (Reg. No. 22,035)  
Michael I. Rackman (Reg. No. 20,639)  
James Reisman (Reg. No. 22,007)  
Barry A. Cooper (Reg. No. 25,204)  
David S. Kashman (Reg. No. 28,725)  
Allen I. Rubenstein (Reg. No. 27,673)  
Jeffrey M. Kaden (Reg. No. 31,268)

Amy B. Goldsmith (Reg. No. 33,700)  
Norbert P. Holler (Reg. No. 17,816)  
Tiberiu Weisz (Reg. No. 29,876)  
Maria A. Savio (Reg. No. 31,565)  
Raymond B. Churchill, Jr. (Reg. No. 44,617)  
Steven Stern (Reg. No. 50,320)

whose address is c/o Gottlieb, Rackman & Reisman, P.C., 270 Madison Avenue, New York NY 10016 (telephone (212) 684-3900), jointly and severally, as my attorneys and/or agents, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. Direct all

correspondence and telephone calls to: (check one) ☒ Tiberiu Weisz, Esq. at the address and telephone number shown above. ☐ Customer Number \_\_\_\_\_

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Hyo-Soo LEE  
Inventor's Signature [Signature] Date July 28, 2003  
Residence 103-2003, Seonbimaecul 1-Danji Apt., Songchon-dong, Daedeok-gu, Daejeon 306-775, Korea  
Citizenship Republic of Korea  
Post Office Address 314, Maetan-3dong, Paldal-gu, Suwon-si, Kyunggi-Do 442-743, Republic of Korea

Full name of second joint inventor, if any Young-Hwan SHIN  
Inventor's Signature [Signature] Date July 28, 2003  
Residence 510-704, Expo Apt., Jeonmin-dong, Yuseong-gu, Daejeon 305-762, Korea  
Citizenship Republic of Korea  
Post Office Address 314, Maetan-3dong, Paldal-gu, Suwon-si, Kyunggi-Do 442-743, Korea

Full name of third joint inventor, if any Chong-Ho KIM  
Inventor's Signature [Signature] Date July 28, 2003  
Residence 301-1204, Hyosung Apt., Biha-dong, Heungdeok-gu, Cheongju-si, Chungchungbuk-do 361-773, Korea  
Citizenship Republic of Korea  
Post Office Address 314, Maetan-3dong, Paldal-gu, Suwon-si, Kyunggi-Do 442-743, Republic of Korea

Full name of fourth joint inventor, if any \_\_\_\_\_  
Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_  
Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of fifth joint inventor, if any \_\_\_\_\_  
Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_  
Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of sixth joint inventor, if any \_\_\_\_\_  
Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_  
Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_